PCN Number: 20220525000.1				PCN D	ate:			
Title: Qualification of Cu as an alternate bond wire for select devices								
Customer Conta	ect: <u>PCN</u>	<u>Manager</u>	Dept:	Quality Serv				
Proposed 1 st Ship Date: Aug		Aug 24		Sample Requests accepted until: June 26,			26, 2022	
	*Sample requests received after June 26, 2022 will not be supported.							
Change Type:					- Cite			
Assembly Site Design Assembly Process Data Sh			aaat	_	Wafer Bump Site Wafer Bump Material			
Assembly Pro		L					p Process	
Mechanical S		ion Part number change			Wafer Fab Site			
	Packing/Shipping/Labeling Test Pro-			ocess		Wafer Fab Materials		
					Wafe	Wafer Fab Process		
			PCN	Details				
Description of C	Change:							
This PCN is to inform of the qualification of an alternate bond wire qualification as follows:								
Current Bond wire/Diameter (all bond wires)				Additional Bond wire & diameter (die to leadframe only)				
	Au, 0	.96 mil		Cu, 0.96 mil				
Reason for Cha								
Continuity of sup						-1	- 1	
electrical prop		lology tr	enas ana l	use wiring with enh	anced me	cnanica	ai and	
		n our As	sembly/Te	st production sites.				
3) Cu is easier to				p				
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):								
None								
Impact on Environmental Ratings								
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.								
RoHS REACH Green Status IEC 62474				EC 62474				
No Change No Change			No Change	No Change				
Changes to product identification resulting from this PCN:								
None								

I	Product Affected:			
	BQ7693000DBT	BQ7693004DBTR	BQ7694001DBT	BQ7694005DBT
	BQ7693000DBTR	BQ7693005DBT	BQ7694001DBTR	BQ7694005DBTR
	BQ7693001DBT	BQ7693005DBTR	BQ7694002DBT	BQ7694006DBT
	BQ7693001DBTR	BQ7693006DBT	BQ7694002DBTR	BQ7694006DBTR
	BQ7693002DBT	BQ7693006DBTR	BQ7694003DBT	BQ7694007DBT
	BQ7693002DBTR	BQ7693007DBT	BQ7694003DBTR	BQ7694007DBTR
	BQ7693003DBT	BQ7693007DBTR	BQ7694004DBT	SN7693003DBT
	BQ7693003DBTR	BQ7694000DBT	BQ7694004DBTR	SN7693003DBTR
	BQ7693004DBT	BQ7694000DBTR		



TI Information Selective Disclosure

Qualification Results				
Data Displayed as: Number of lots / Total sample size / Total failed				

Туре	Test Name / Condition	Duration	Qual Device: BQ7693003DBTR	Qual Device: BQ7694003DBTR	QBS Process Reference: <u>TPS2543QRTE</u>	QBS Package Reference: <u>BQ8040DBT</u>	QBS Package Reference: <u>TAS5086DBT</u>
AC	Autoclave 121C	96 hours	-	3/231/0	3/231/0	-	3/231/0
CDM	ESD - CDM	1500 V	-	-	1/3/0	-	-
ED	Electrical Characterization	Per Datasheet Parameters	-	-	3/Pass	1/Pass	-
ELFR	Early Life Failure Rate, 150C	24 Hours	-	-	3/2400/0	-	-
HAST	Biased HAST 110C/85%RH	264 Hours	1/77/0	-	-	-	-
HAST	Biased HAST 130C/85%RH	96 Hours	-	-	3/231/0	-	3/226/0
HBM	ESD - HBM	4000 V	-	-	1/3/0	-	-
HTOL	Life Test, 150C	408 Hours	-	-	3/231/0	-	-
HTOL	Life Test, 155C	240 hours	-	-	-	-	3/231/0
HTSL	High Temp Bake 150C	1000 hours	1/77/0	3/231/0	-	-	-
HTSL	High Temp Bake 170C	420 hours	-	-	-	-	3/231/0
HTSL	High Temp Bake 175C	500 Hours	-	-	3/149/0	-	-
LU	Latch-up	-	-	-	1/6/0	-	-
PTC	Power Temp Cycle, - 40/125C	1000 Cycles	-	-	1/45/0	-	-
TC	Temp Cycle -65/150C	500 Cycles	1/77/0	3/231/0	3/231/0	1/77/0	3/231/0

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours

- The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

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